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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: V. Srikant

Examiner: TBA

Serial No: 10/037,221

Group Art Unit: TBA

Filed: 11/9/01

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MAR 19 2002  
TECHNOLOGY CENTER 2800INFORMATION DISCLOSURE STATEMENT  
UNDER 37 C.F.R. §§ 1.56, 1.97 - 1.98Asst. Commissioner of Patents and Trademarks  
Washington, DC 20231

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference(s) is enclosed.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

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Date: 7 Feb 02

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| I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Asst. Commissioner of Patents and Trademarks, Washington, D.C. 20231 |          |
| on  | 7 Feb 02 |
| Date of Deposit   |          |
| William J. Chervenak  |          |
| Name of applicant, assignee, or   |          |
| Registered Representative   |          |
| <i>William J. Chervenak</i>   |          |
| Signature   |          |
| 7 Feb 02  |          |
| Date of Signature   |          |